	K. 16. C <u>IN THE UNITED STATES PAT</u>	Express Mail Mailing Laber No.
Serial No Filed: He	rewith	<ul> <li>Date of Deposit <u>August 16, 2000</u></li> <li>I hereby certify that this paper or fee is bei</li> </ul>
For: Disj Art Unit: Examine:	r:	<ul> <li>deposited with the United States Postal Servi</li> <li>"Express Mail Post Office to Addressee" servi</li> <li>under 37 CFR 1.10 on the date indicated abo and is addressed to the Assistant Commission</li> <li>MENT COVER SHEEP atents, Washington, D.C 20231</li> </ul>
Washing	Commissioner for Patents on, D. C. 20231	Name <u>Nathan</u> Willer (August 15, 20
Sir:	Please record the attached original document or copy the	hereof. Total number 309 puges (with cover sheet): 2
1. <u>Yukio</u>	Name of Conveying Party(ies): TANAKA	5. Name and Address of Party to Whom Correspondence Concerning Document Should be Mailed:
	Name and Address of Receiving Party(ies): <u>Semiconductor Energy Laboratory Co., Ltd.</u> s: <u>398, Hase, Atsugi-shi, Kanagawa-ken</u> <u>243-0036 Japan</u>	Edward D. Manzo, Esq.         COOK, ALEX, McFARRON, MANZO, CUMMINGS &         MEHLER, LTD.         200 West Adams Street, Suite 2850         Chinese Winsin (2000)
2b. Name: Addres	Name and Address of Receiving Party(ies):	Chicago, Illinois 60606       4         6.       Total Number of Applications and Patents         Involved:       1
Merg Secu	Nature of Conveyance gnment er nity Agreement ge of Name	<ul> <li>7. Total Fee (37 CFR 3.41): \$40.00</li> <li>7a. X Enclosed</li> <li>7b. X Authorized to be Charged to Deposit Account For Any Deficiency</li> </ul>
Othe	F	8. Deposit Account Number: <u>50/1039</u> (A duplicate copy of this page is attached)
the exe	Application Number(s) or Patent number(s) (If this nt is being filed together with a new application, cution date of the application is: <u>8/09/00</u>	9. Statement and Signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
	ent Application No.(s)	Mark J. Murphy Name of Person Signing Signature
2000 BALE 581	XAND 00000031 09639973 40.00 DP	Reg. No. 34,225 Date: August 15, 2000
	DO NOT US	E THIS SPACE

## ASSIGNMENT

*Identity Of The Patent Application.* I am the inventor (or one joint inventor) of a patent application that I am assigning. The patent application I am assigning is entitled <u>DISPLAY DEVICE AND A DRIVER CIRCUIT THEREOF</u> which I executed herewith. If the patent application has already been filed, it received serial number \_\_\_\_\_\_ and bears a filing date of \_\_\_\_\_\_.

The Assignee and The Assignment. I assign my patent rights to <u>Semiconductor Energy Laboratory</u> <u>Co., Ltd.</u> a corporation organized according to the laws of Japan, having a place of business at <u>398, Hase</u>, <u>Atsugi-shi, Kanagawa-ken 243-0036 Japan</u> (hereinafter "the Assignee"). The rights I assign are my entire right, title and interest in the invention or improvements disclosed in the patent application and any and all other applications for United States Letters Patent which I may file, either solely or jointly with others, on the invention or improvements, including all continuations, divisionals, and continuations-in-part, and in any and all United States Letters Patent which may be obtained on any of said applications, and in any reissue or extension thereof. I also assign to the Assignee all priority rights under the International Convention. I agree to execute, at the request of the Assignee, all documents in connection with any application for United States letters patent therefor.

**Payment Received.** I am making this assignment in consideration of One Dollar and other good and valuable consideration. I acknowledge the receipt and sufficiency of the consideration.

Authorizations. I request the U.S. Commissioner of Patents and Trademarks to issue the Letters Patent to the Assignee. I authorize the attorney(s) of record in the application to insert in this assignment document the date and serial number of the application.

**Further Acts.** I agree, upon the request and at the expense of the Assignee, to execute any divisional, continuation or substitute application for the invention or improvements, and any oath, declaration or affidavit relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon the application. I agree to perform, upon request, any affirmative acts to obtain said Letters Patent of the United States and to vest in the Assignee all rights therein, so that the Letters Patent will be held and enjoyed by the Assignee, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me if this assignment had not been made.

*Interference.* In the event that any application or Letters Patent that I now assign becomes involved in interference, I agree to cooperate to the best of my ability in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof.

Name: Yukio TANAKA	<u>08/09/2000</u> Date
Name:	Date
Name:	Date
Name:	Date